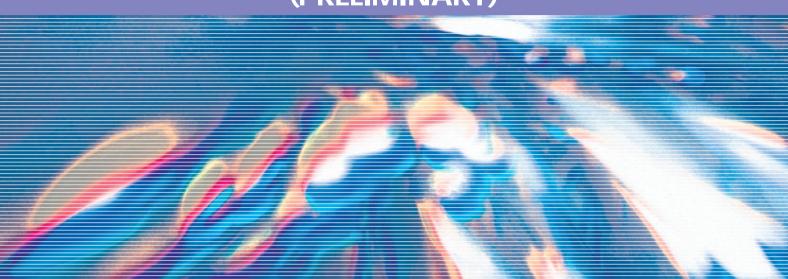
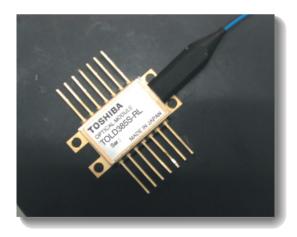
TOSHIBA

Optical Communication Devices 2.5 Gb/s Optical Transmitter

TOLD385S-RL Series (PRELIMINARY)





APPLICATION

● SONET / SDH (OC-48 / STM-16) applications

FEATURES

- 1.55 μm DFB LD
- ullet Included Bias-tee with 20 Ω resistance
- Included Thermo-Electric Cooler (TEC)
- Standard 14-pin butterfly package
- Dispersion penalty: 2dB (max. @ 80 km distance)

TOLD385S-RL Series

ABSOLUTE MAXIMUM RATINGS

Item	Min	Max	Unit	
Storage temperature	-40	85	°C	
Operating case temperature	-5	70	°C	
LD forward current	-	150	mA	
LD reverse voltage	-	2	V	
PD reverse current	-	2	mA	
PD reverse voltage	-	15	V	
TEC current	-	1.4	А	
Package mounting screw torque	-	0.2	Nm	
Lead soldering temperature	-	260	°C	
Lead soldering time	-	10	sec	

ELECTRICAL AND OPTICAL CHARACTERISTICS

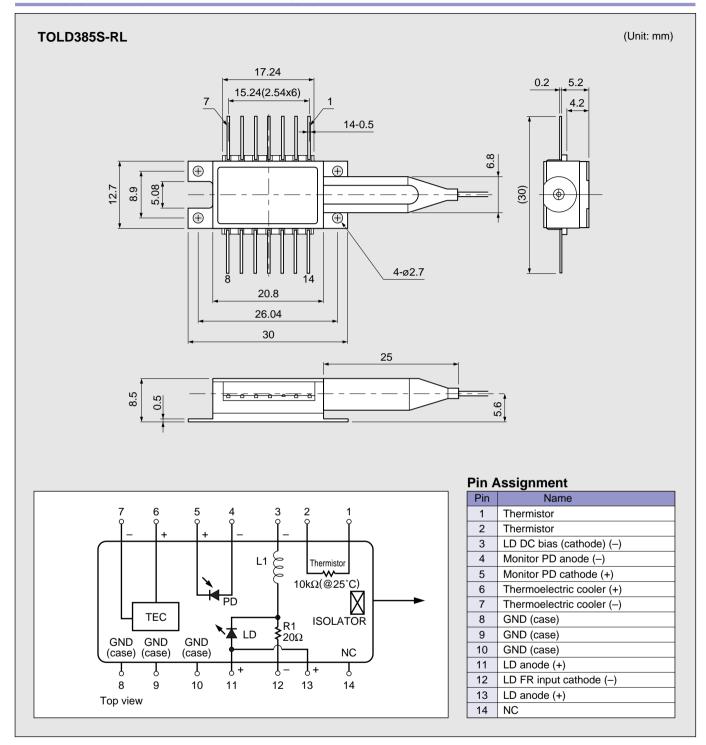
Item	Condition	Min	Тур.	Max	Unit
Threshold current	CW	-	15	30	mA
Operating current	Pop = 2 mW, CW	-	-	85	mA
Slope efficiency	Pop = 2 mW, CW	0.05	-	0.15	mW/mA
Forward voltage	Pop = 2 mW, CW	-	1.3	2	V
Laser set temperature	-	15	-	35	°C
Input Impedance	-	-	25	-	Ω
Bandwidth	−3dB, Pop = 2 mW	2.7	-	-	GHz
Rise time	20% to 80%	-	-	160	ps
Fall time	80% to 20%	-	-	160	ps
Monitor PD current	Pop = 2 mW, CW	50	-	1000	uA
Monitor PD dark current	VrP = 5 V	-	1	10	nA
Peak wavelength	ITU-T grid compliant	1528	-	1564	nm
Spectral width	Pop = 2mW, -20dB, *1	-	-	1.0	nm
Side mode suppression ratio	Pop = 2mW, CW	33	-	-	dB
Dispesion penalty	*1, *2	-	-	2	dB
Thermistor resistance	$T_{LD} = 25^{\circ}C$	-	10	-	kΩ
Thermistor B constant	25°C/50°C	-	3400	-	К
TEC current	$\Delta T = 45^{\circ}C$	-	-	1.0	А
TEC voltage	$\Delta T = 45^{\circ}C$	-	-	2.0	V

Notes:

^{*1: 2.48832}Gb/s, PRBS2²³ –1, NRZ, extinction ratio = 9dB

^{*2:} Pop (Operating output power) = 2 mW, 80km transmission distance through general optical fiber

DIMENSIONAL OUTLINE AND PIN ASSIGNMENT



PRECAUTIONS

- (a) Power supply: Transient electric spike may cause a damage to the laser or the photodiode.
 - A surge-free power supply and a slow starter circuit should be used.
 - To avoid causing an electrical surge, pins should not be connected or disconnected on the test fixture before turning the power off.
- (b) The product should be grounded for obtaining the performance.
- (c) Safety: The laser emits invisible light harmful to the human eyes. Direct viewing should be avoided.

Toshiba America Electronic Components, Inc.

Headquarters-Irvine, CA

9775 Toledo Way, Irvine, CA 92618, U.S.A. Tel: (949)455-2000 Fax: (949)859-3963

Deerfield, IL(Chicago)

One Pkwy., North, Suite 500, Deerfield, IL 60015, U.S.A.

Tel: (847)945-1500 Fax: (847)945-1044

Edison, NJ

2035 Lincoln Hwy. #3000, Edison. NJ 08817, U.S.A. Tel: (732)248-8070 Fax: (732)248-8030

Raleigh, NC

5511 Capitol Center Dr., #114, Raleigh, NC 27606, U.S.A. Tel: (919)859-2800 Fax: (919)859-2898

Richardson, TX(Dallas)

777 East Campbell Rd., #650, Richardson, TX 75081, U.S.A. Tel: (972)480-0470 Fax: (972)235-4114

Wakefield, MA(Boston)

401 Edgewater Place, #360, Wakefield, MA 01880, U.S.A. Tel: (781)224-0074 Fax: (781)224-1095

Toshiba Electronics Europe GmbH

Düsseldorf Head Office

Hansaallee 181, D-40549 Düsseldorf, Germany

Tel: (0211)5296-0 Fax: (0211)5296-400

Toshiba Electronics Italiana S.R.L.

Centro Direzionale Collegni Palazzo Perseo 3, 1-20041 Agrate Brianza, (Milan), Italy Tel: (039)68701 Fax:(039)6870205

Toshiba Electronics(UK) Ltd.

Riverside Way, Camberley Surrey, GU15 3YA, U.K.

Tel: (01276)69-4600 Fax: (01276)69-4800

Toshiba Electronics Scandinavia A B

Gustavslundsvägen 12, 2nd Floor, S-161 15 Bromma, Sweden Tel: (08)704-0900 Fax: (08)80-8459

Toshiba Electronics Asia (Singapore) Pte. Ltd.

Singapore Head Office

438B Alexandra Road, #06-08/12 Alexandra Technopark, Singapore 119968 Tel: (278)5252 Fax: (271)5155

Toshiba Electronics Asia, Ltd.

Hong Kong Head Office

Level 11, Tower 2, Grand Century Place, No.193, Prince Edward Road West, Mona Kok, Kowloon, Hona Kona Tel: 2375-6111 Fax: 2375-0969

Beijing Office

Rm 714. Beijing Fortune Building. No.5 Dong San Huan Bei-Lu, Chao Yang District, Beijing, 100004, China Tel: (010)6590-8796 Fax: (010)6590-8791

Toshiba Electronics Korea Corporation

Seoul Head Office

14/F, KEC B/D, 275-7 Yangjae-dong, Seocho-ku, Seoul, Korea Tel: (02)589-4300 Fax: (02)589-4302

Toshiba Technology Development (Shanghai) Co., Ltd.

23F, HSBC Tower, 101 Yin Cheng East Road, Pudong New Area, Shanghai, 200120 China Tel: (021)6841-0666 Fax: (021)6841-5002

Toshiba Electronics Taiwan Corporation

Taipei Head Office

17F, Union Enterprise Plaza Bldg. 109 Min Sheng East Rd., Section 3, 10446 Taipei, Taiwan Tel: (02)2514-9988 Fax: (02)2514-7892

(As of August, 2001)

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TOSHIBA CORPORATION

Electronic Devices Sales & Marketing Division 1-1, Shibaura 1-chome, Minato-ku, Tokyo, 105-8001, Japan Tel: +81-3-3457-3405 Fax: +81-3-5444-9431

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